

# Preface

This MSIA series proceeding includes original, peer-reviewed research papers from the International Conference on Materials Science and Industrial Applications (MSIA 2019: <http://www.icmsia.org/>), and held on January 12-13, 2019 in Wuhan, China.

MSIA aims to bring together leading academic scientists, researchers and research scholars to exchange and share their experiences and research results on all aspects of Materials Science and Industrial Applications. It also provides a platform for academic scientists, research scholars, doctors, engineers, doctoral students and related professionals to present and discuss the most recent innovations, trends, and concerns as well as practical challenges encountered and solutions adopted in the fields of Materials Science and Industrial Applications. All authors and participants are kindly encouraged to contribute to and help shape the conference through submissions of their research abstracts, papers and posters.

This MSIA 2019 received 176 manuscripts, and only 33 submissions had been accepted by our reviewers and 42 one-page submissions made an oral presentation during MSIA 2019 without paper publication. All submissions to the MSIA 2019 were sent to two reviewers and evaluated based on originality, technical and research content, relevance to conference, contributions, and readability. The full paper submissions were chosen based on technical merit, interest, applicability, and how well they fit a coherent and balanced technical program.

Hopefully, all participants and other interested readers could benefit scientifically from the proceedings and find it stimulating in the process.

With our warmest regards,

Zhibin You  
Conference Organizing Chair  
Wuhan, China

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